

# N-Channel Enhancement-Mode **Vertical DMOS FET**

#### **Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral source-drain diode
- High input impedance and high gain

#### **Applications**

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

#### **General Description**

This enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Ordering Information

Do	Device	Package Option	BV <sub>DSS</sub> /BV <sub>DGS</sub>	$R_{ exttt{DS(ON)}}$	$V_{GS(TH)}$	D(ON)
De		TO-92	(V)	(max) (Ω)	(max) (V)	(min) (mA)
VN	4012	VN4012L-G	400	12	1.8	150

<sup>-</sup>G indicates package is RoHS compliant ('Green')





## **Absolute Maximum Ratings**

Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	BV <sub>DGS</sub>
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C
Soldering temperature*	300°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All Package may or may not include the following marks: Si or voltages are referenced to device ground.

## **Pin Configuration**



## **Product Marking**

Si VN 4012L YYWW

YY = Year Sealed WW = Week Sealed \_\_ = "Green" Packaging

TO-92 (L)

Distance of 1.6mm from case for 10 seconds.

#### **Thermal Characteristics**

Package	I <sub>D</sub> (continuous) <sup>†</sup> (mA)	I <sub>D</sub> (pulsed) (mA)	Power Dissipation @T <sub>c</sub> = 25°C (W)	θ <sub>jc</sub> (°C/W)	θ <sub>ja</sub> (°C/W)	<sub>DR</sub> † (mA)	I <sub>DRM</sub> (mA)
TO-92	160	650	1.0	125	170	160	650

#### Notes:

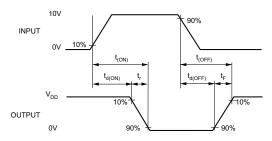
## **Electrical Characteristics** (T<sub>A</sub> = 25°C unless otherwise specified)

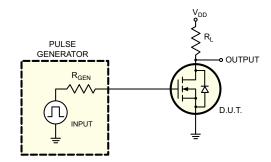
Sym	Parameter	Min	Тур	Max	Units	Conditions	
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	400	-	1	V	$V_{GS} = 0V$ , $I_D = 100\mu A$	
$V_{\rm GS(th)}$	Gate threshold voltage	0.6	-	1.8	V	$V_{GS} = V_{DS}$ , $I_D = 1.0 \text{mA}$	
I <sub>GSS</sub>	Gate body leakage	-	-	10	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
	Zero gate voltage drain current		-	1	μΑ	$V_{GS} = 0V$ , $V_{DS} = 0.8$ Max Rating	
I <sub>DSS</sub>			-	100		$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_{A} = 125$ °C	
I <sub>D(ON)</sub>	On-state drain current	0.15	0.3	-	Α	$V_{GS} = 4.5V, V_{DS} = 10V$	
D	Static drain-to-source on-state	-	9.5	12	Ω	$V_{GS} = 4.5V, I_{D} = 100mA$	
R <sub>DS(ON)</sub>	resistance	-	17	30		$V_{GS} = 4.5V, I_{D} = 100mA, T_{A} = 125^{\circ}C$	
G <sub>FS</sub>	Forward transductance	125	350	ı	mmho	$V_{DS} = 15V, I_{D} = 100mA$	
C <sub>iss</sub>	Input capacitance	-	-	110		V <sub>GS</sub> = 0V,	
C <sub>oss</sub>	Common source output capacitance	-	-	30	pF	$V_{DS} = 25V$ ,	
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	10		f = 1.0MHz	
t <sub>r</sub>	Rise time	-	-	20			
t <sub>d(ON)</sub>	Turn-on delay time Fall time		-	20	ns	V <sub>DD</sub> = 25V,	
t <sub>f</sub>			-	65		$I_D = 100 \text{mA},$ $R_{GEN} = 25 \Omega$	
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	65		32.1	
V <sub>SD</sub>	Diode forward voltage drop	_	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 160mA	

#### Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

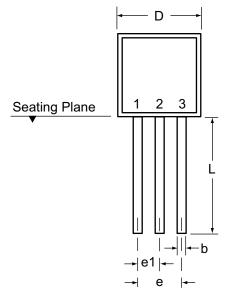
# **Switching Waveforms and Test Circuit**

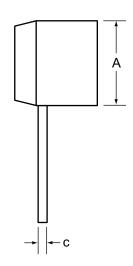




<sup>†</sup>  $I_D$  (continuous) is limited by max rated  $T_i$ .

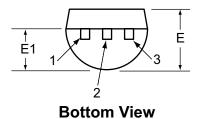
# 3-Lead TO-92 Package Outline (L)





**Front View** 

**Side View** 



Symbol		Α	b	С	D	E	E1	е	e1	L
	MIN	.170	.014 <sup>†</sup>	.014 <sup>†</sup>	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
(11101100)	MAX	.210	.022 <sup>†</sup>	.022 <sup>†</sup>	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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<sup>\*</sup> This dimension is not specified in the JEDEC drawing.

<sup>†</sup> This dimension differs from the JEDEC drawing.